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To the Director of the U.S. Patent and Trademark Office, at the address(es) below.

1. Name of conveying party(ies)

Jian Feng
Hung-Shen Chu
Shengmei Zheng

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Hong Kong Applied Science and Technology
Name: Research Institute Company Limited

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Street Address: 3rd Floor, Building 6, 2 Science Park

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City: Shatin, New Territories

State: _____

Country: Hong Kong Zip: _____

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance/Execution Date(s):

Execution Date(s) October 27, 2006

- Assignment Merger
- Security Agreement Change of Name
- Joint Research Agreement
- Government Interest Assignment
- Executive Order 9424, Confirmatory License
- Other _____

4. Application or patent number(s):

This document is being filed together with a new application.

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address to whom correspondence concerning document should be mailed:

Name: DEEPAK MALHOTRA

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6. Total number of applications and patents involved: one (1)

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- Authorized to be charged by credit card
- Authorized to be charged to deposit account
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- None required (government interest not affecting title)

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9. Signature:

D. Malhotra
Signature

Oct. 27, 2006
Date

DEEPAK MALHOTRA
Name of Person Signing

Total number of pages including cover sheet, attachments, and documents: 3

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
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ASSIGNMENT

PARTIES TO THE ASSIGNMENT:

INVENTORS:

Jian FENG a Chinese citizen of Rm C, 23F, Block 7, Nan Fung Sun Chuen, Quarry Bay, Hong Kong,

Hung-Shen CHU a Taiwanese citizen of 8F, No. 82-1, Lane 531, Section 1, Guangfu Rd., Hsinchu, Taiwan, and

Shengmei ZHENG a Chinese citizen of Tower A 505, HKUST, Clear Water Bay, Hong Kong

ASSIGNEE:

Hong Kong Applied Science and Technology Research Institute Company Limited, a Hong Kong company of 3rd Floor, Building 6, 2 Science Park West Avenue, Hong Kong Science Park, Shatin, New Territories, Hong Kong

BACKGROUND OF THIS ASSIGNMENT:

Inventors have conceived certain new and useful inventions disclosed in Hong Kong patent application 06111680.6 filed Oct 23, 2006 and a United States patent application titled Light Emitting Diode Device, Method of Fabrication and Use Thereof.

ASSIGNEE desires to acquire the entire right, title and interest in said inventions and with respect to any Letters Patent that may be granted with respect to the inventions in both the United States and in all foreign countries.

THE PARTIES AGREE AS FOLLOWS:

In consideration of good and valuable consideration, the receipt of which is hereby acknowledged, INVENTORS have sold, assigned and transferred to ASSIGNEE the full and exclusive right to said inventions in the United States and in all foreign countries.

INVENTORS do hereby sell, assign and transfer to ASSIGNEE the entire right, title and interest in the above-identified Hong Kong and United States applications with this assignment and to any reissues, divisions or continuations thereof, and hereby authorizes the Commissioner of Patents and Trademarks to issue such Letters Patent to ASSIGNEE for the sole use of ASSIGNEE, its successors or assigns.

INVENTORS further agree to execute, at the request and expense of ASSIGNEE such other formal documents as may be required to fully convey the interest transferred herein and will similarly execute any applications papers required for the filing of any division, continuation or reissue of the patent application or resulting Letters Patent; and will generally do everything necessary or desirable to obtain and enforce proper protection for the inventions assigned hereby.

INVENTORS further assign to ASSIGNEE the whole right, title and interest in the inventions disclosed in the applications throughout all countries foreign to Hong Kong and United States. ASSIGNEE is hereby authorized to apply for patents relating to the inventions in its own name in countries where such procedure is proper; to claim the benefit of the International Convention; to file and prosecute International Applications relating to the inventions under the Patent Cooperation Treaty; and to file and prosecute applications relating to the inventions under the European Patent Convention. INVENTORS agree to execute applications relating to the inventions in those countries and under those conventions where it is necessary that the same be executed by the inventor, and to execute assignments of such applications and the resulting Letters Patent to ASSIGNEE as well as all other necessary papers in relation to such applications and Letters Patent.

Signed at Shatin, Hong Kong on 27 Oct 2006, 2006



Jian FENG, Inventor

Signed at Shatin, Hong Kong on Oct 27, 2006



Hung-Shen CHU, Inventor

Signed at Shatin, Hong Kong on Oct 27, 2006



Shengmei ZHENG, Inventor